INTEGRATED CIRCUITS

DATA SHEET

74F06, **74F06A**, **74F07**, **74F07A**Inverter/buffer drivers

Product specification

1992 Jul 24

IC15 Data Handbook





Hex inverter/buffer drivers (open-collector)

74F06, 74F06A, 74F07, 74F07A

FEATURES OF 74F06, 74F07

- Open Collector output drive 64mA
- High speed
- 12V output termination voltage
- Symmetrical propagation delays

FEATURES OF 74F06A, 74F07A

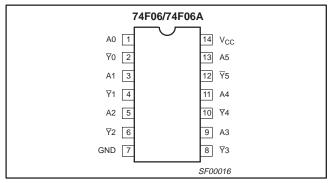
- Open Collector output drive 48mA
- High speed
- 30V output termination voltage
- Replaces 74F06 and 74F07
- Improved performance upgrade for 74F06 and 74F07
- Reduced I_{OH} leakage @ 30V

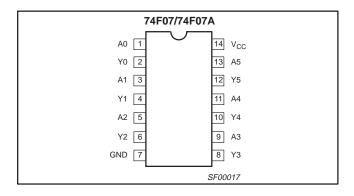
TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F06	3.5ns	30mA
74F06A	9.0ns	30mA
74F07	4.5ns	32mA
74F07A	10.0ns	32mA

ORDERING INFORMATION

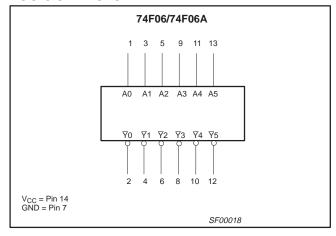
DESCRIPTION	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = 0^{\circ}C \text{ to } +70^{\circ}C$	PKG DWG #
14-pin plastic Dual In-line Package	N74F06N, N74F06AN	SOT27-1
14-pin plastic Small Outline	N74F07D, N74F07AD	SOT108-1

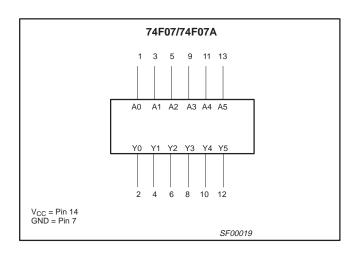
PIN CONFIGURATIONS





LOGIC SYMBOLS



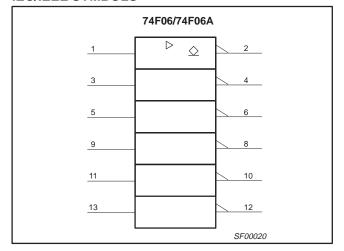


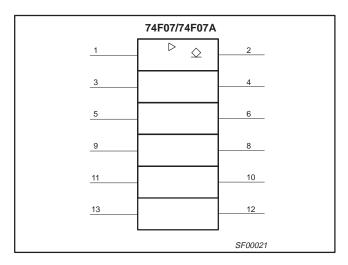
Philips Semiconductors Product specification

Hex inverter/buffer drivers (open-collector)

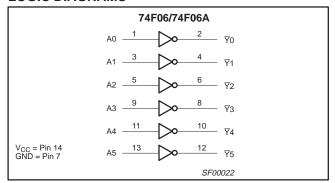
74F06, 74F06A, 74F07A

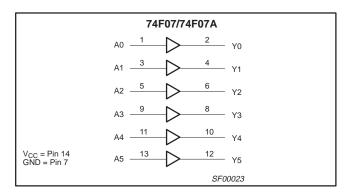
IEC/IEEE SYMBOLS





LOGIC DIAGRAMS





INPUT AND OUTPUT LOADING AND FAN OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
An	Data inputs ('F06, 'F07)	1.0/1.0	20μA/0.6mA
An	Data inputs ('F06A, 'F07A)	1.0/0.7	20μA/0.4mA
₹n	Data outputs ('F06)	OC/106.7	OC/64mA
₹n	Data outputs ('F06A)	OC/80	OC/48mA
Yn	Data outputs ('F07)	OC/106.7	OC/64mA
Yn	Data outputs ('F07A)	OC/80	OC/48mA

NOTES:

- 1. One (1.0) FAST unit load is defined as: $20\mu\text{A}$ in the High state and 0.6mA in the Low state.
- 2. OC = Open Collector

FUNCTION TABLE

INPUTS	OUTF	PUTS
	'F06, 'F06A	'F07, 'F07A
An	Ϋ́n	Yn
L	Н	L
Н	L	Н

NOTES:

- 1. H = High voltage level
- 2. L = Low voltage level

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Hex inverter/buffer drivers (open-collector)

74F06, 74F06A, 74F07, 74F07A

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage		-0.5 to +7.0	V
I _{IN}	Input current		-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	-0.5 to 12	V	
		'F06A, 'F07A	-0.5 to 30	V
l _{out}	Current applied to output in Low output state	'F06, 'F07	128	mA
		96	mA	
T _{amb}	Operating free air temperature range	0 to +70	°C	
T _{stg}	Storage temperature range		-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			LIMITS		UNIT
		MIN	NOM	MAX	1	
V _{CC}	Supply voltage		4.5	5.0	5.5	V
V _{IH}	High-level input voltage		2.0			V
V _{IL}	Low-level input voltage				0.8	V
I _{lk}	Input clamp current				-18	mA
V _{OH}	High-level output voltage	'F06, 'F07			12	V
		'F06A, 'F07A			30	V
I _{OL}	Low-level output current	'F06, 'F07			64	mA
		'F06A, 'F07A			48	mA
T _{amb}	Operating free air temperature range		0		+70	°C

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74F06, 74F06A, 74F07, 74F07A

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMET	ER		TEST	CONDITION	S ¹		LIMITS		UNIT
					MIN	TYP ²	MAX			
I _{OH}	High-level output	'F06, 'F07	,	$V_{CC} = MIN, V_{IL}$ $V_{OH} = MAX, V_{II}$			250	μΑ		
	current	'F06A, 'F0)7A	$V_{OH} = MAX, V_{II}$				100	μΑ	
V _{OL}	Low-level output voltage			$V_{CC} = MIN,$ $V_{IL} = MAX,$		0.30	0.50	V		
				$V_{IH} = MIN$		0.30	0.50	V		
V _{IK}	Input clamp voltage			$V_{CC} = MIN, I_I = I_{IK}$				-0.73	-1.2	V
II	Input current at maximun	$V_{CC} = MAX, V_I = 7.0V$					100	μΑ		
I _{IH}	High-level input current			$V_{CC} = MAX, V_I = 2.7V$					20	μΑ
I _{IL}	Low-level input current	'F06, 'F07	,	$V_{CC} = MAX, V_I = 0.5V$					-0.6	mA
		'F06A, 'F0)7A	1					-0.4	mA
I _{CC}	Supply current (total)	74F06,	Іссн	$V_{CC} = MAX$				5.0	8.0	mA
		74F06A	I _{CCL}	1		30	43	mA		
		74F07,	I _{CCH}	1		10	14	mA		
		74F07A	I _{CCL}	1				32	45	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

AC ELECTRICAL CHARACTERISTICS

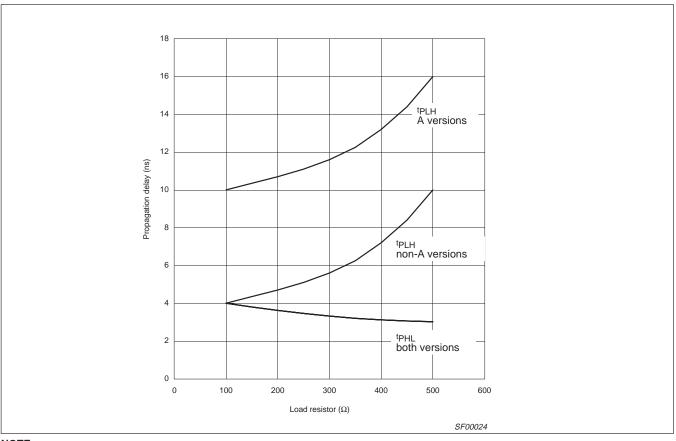
		PARAMETER			LIMITS						
SYMBOL	PARAMETER				C _C = +5.0 mb = +25° 50pF, R _L =	V C 100Ω	V _{CC} = +5. T _{amb} = 0°C C _L = 50pF,	UNIT			
			Min	Тур	Max	Min	Max				
t _{PLH} Propagation delay	Propagation delay	'F06	Waveform 1	2.0 1.5	3.5 3.0	6.0 5.5	1.5 1.0	6.5 6.0	ns		
t _{PHL}	An to \overline{Y} n	'F06A	wavelollii i	5.0 2.0	9.0 4.0	11.0 6.0	4.0 2.0	15.0 8.0	ns		
t _{PLH}	t _{PLH} Propagation delay		Waveform 2	2.0 3.0	4.0 5.0	6.0 7.0	2.0 2.5	6.5 7.5	ns		
t _{PHL}	An to Yn	'F07A	vvavei0fffi 2	6.0 5.0	10.5 7.5	13.0 10.0	5.0 4.0	17.0 13.0	ns		

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All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, IOS tests should be performed last.

TYPICAL PROPAGATION DELAYS VERSUS LOAD FOR OPEN COLLECTOR OUTPUTS



NOTE:

When using Open-Collector parts, the value of the pull-up resistor greatly affects the value of the t_{PLH} . For example, changing the specified pull-up resistor value from 500Ω to 100Ω will improve the t_{PLH} up to 50% with only a slight increase in the t_{PHL} . However, if the value of the pull-up resistor is changed, the user must make certain that the total t_{OL} current through the resistor and the total t_{IL} 's of the receivers does not exceed the t_{OL} maximum specification.

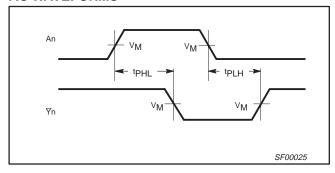
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Hex inverter/buffer drivers (open-collector)

74F06, 74F06A, 74F07, 74F07A

AC WAVEFORMS



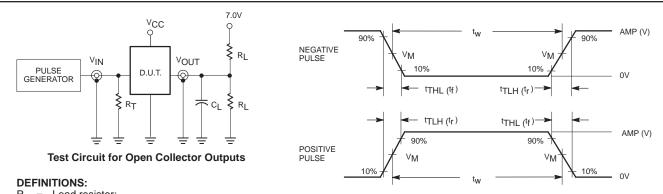
Waveform 1. Propagation delay for inverting outputs NOTE:

^tPLH tPHL → $^{\text{V}}\text{M}$

Waveform 2. Propagation delay for non-inverting outputs

For all waveforms, $V_M = 1.5V$.

TEST CIRCUIT AND WAVEFORMS



= Load resistor;

see AC electrical characteristics for value.

Load capacitance includes jig and probe capacitance; see AC electrical characteristics for value.

Termination resistance should be equal to Z_{OUT} of pulse generators.

Input Pulse Definition

	family	INP	INPUT PULSE REQUIREMENTS										
		amplitude	V _M	rep. rate	t _w	t _{TLH}	t _{THL}						
	74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns						

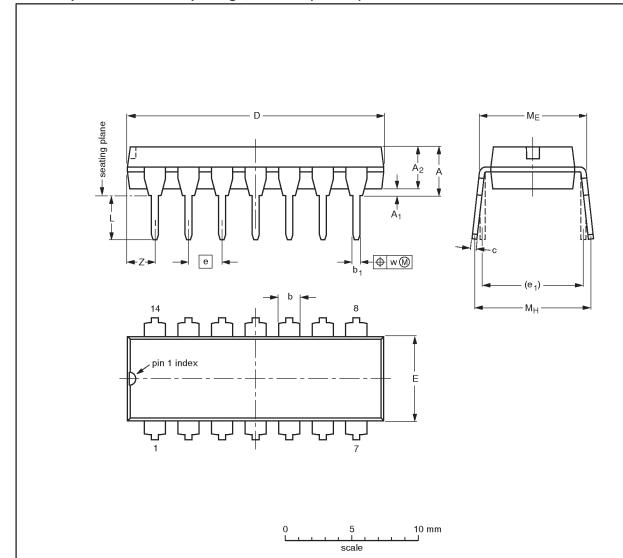
SF00027

Inverter/buffer drivers

74F06, 74F06A, 74F07, 74F07A

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	PROJECTION	ISSUE DATE		
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11

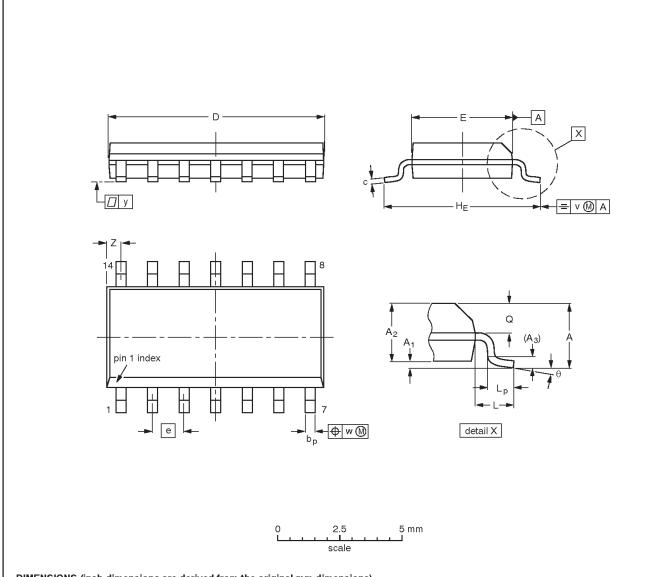
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Inverter/buffer drivers

74F06, 74F06A, 74F07, 74F07A

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1990E DATE
SOT108-1	076E06S	MS-012AB			-95-01-23- 97-05-22

1992 Jul 24

Philips Semiconductors Product specification

Inverter/buffer drivers

74F06, 74F06A, 74F07, 74F07A

Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible productions.	

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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